

78 Series Regulators

1A Output 78 series Regulators

500mA Output 78 series Regulators



BA78□□Series, BA78M□□Series

No.12019ECT01

●Description

BA78□□, BA78M□□ series are three-terminal regulators available with several fixed output voltages. It supplies the stable fixed voltage from unstable direct input voltage. The useful output voltage lineup is 5V, 6V, 7V, 8V, 9V, 10V, 12V, 15V, 18V, 20V, 24V with 0.5A / 1A current ability. They have nearly same electric characteristics as competitor products and cover a wide range of application.

●Features

- 1) Built-in over-current protection circuit and thermal shutdown circuit
- 2) High ripple rejection
- 3) Available TO220CP-3, TO252-3 package to a wide range application
- 4) Compatible replacement to competitor products
- 5) Various voltage lineup (5V, 6V, 7V, 8V, 9V, 10V, 12V, 15V, 18V, 20V, 24V)

●Applications

Fixed voltage power supply for TV, Audio components, etc

●Line up

■1A BA78□□Series

Part Number	5V	6V	7V	8V	9V	10V	12V	15V	18V	20V	24V	Package
BA78□□CP	○	○	○	○	○	○	○	○	○	○	○	TO220CP-3
BA78□□FP	○	○	○	○	○	○	○	○	○	○	○	TO252-3

■0.5A BA78M□□Series

Part Number	5V	6V	7V	8V	9V	10V	12V	15V	18V	20V	24V	Package
BA78M□□CP	○	○	○	○	○	○	○	○	○	○	○	TO220CP-3
BA78M□□FP	○	○	○	○	○	○	○	○	○	○	○	TO252-3

●Output Voltage and Marking

Part Number : BA78□□□□ (1A)
a b

Part Number : BA78M□□□□ (0.5A)
a b

Symbol	assignment of output voltage			
a	□□	Output voltage(V)	□□	Output voltage(V)
	05	5.0V typ.	12	12V typ.
	06	6.0V typ.	15	15V typ.
	07	7.0V typ.	18	18V typ.
	08	8.0V typ.	20	20V typ.
	09	9.0V typ.	24	24V typ.
	10	10.0V typ.		
b	Package CP : TO220CP-3 FP : TO252-3			

Symbol	assignment of output voltage			
a	□□	Output voltage(V)	□□	Output voltage(V)
	05	5.0V typ.	12	12V typ.
	06	6.0V typ.	15	15V typ.
	07	7.0V typ.	18	18V typ.
	08	8.0V typ.	20	20V typ.
	09	9.0V typ.	24	24V typ.
	10	10.0V typ.		
b	Package CP : TO220CP-3 FP : TO252-3			

● **Absolute Maximum Rating** (Ta=25°C)

BA78□□CP/FP, BA78M□□CP/FP

Parameter	Symbol	Limits	Unit
Power supply voltage	Vin	35	V
Power Dissipation 1	Pd1	2 ^{*1}	W
		1 ^{*1}	
Power Dissipation 2	Pd2	22 ^{*2}	W
		10 ^{*2}	
Output Current	Io	1 ^{*3}	A
		0.5 ^{*3}	
Operating Temperature Range	Topr	-40~+85	°C
Storage Temperature Range	Tstg	-55~+150	°C
Operating Junction Temperature Range	Tj	-40~+150	°C

*1 Derating in done 16mW/°C(TO220CP-3), 8mW/°C(TO252-3) for temperatures above Ta=25°C

*2 Derating in done 176mW/°C(TO220CP-3), 80mW/°C(TO252-3) for temperatures above Ta=25°C, Mounted on infinity Aluminium heat sink.

*3 Pd, ASO and Tjmax(150°C) should not be exceeded.

● **Operating Conditions**(Ta=25°C, Pd should not be exceeded)

BA78□□CP/FP

Parameter	Symbol	Min.	Max.	Unit.
Input Voltage	BA7805	7.5	25	V
	BA7806	8.5	21	
	BA7807	9.5	22	
	BA7808	10.5	23	
	BA7809	11.5	26	
	BA7810	12.5	25	
	BA7812	14.5	27	
	BA7815	17.5	30	
	BA7818	21	33	
	BA7820	23	33	
	BA7824	27	33	
Output Current	Io	-	1	A

BA78M□□CP/FP

Parameter	Symbol	Min.	Max.	Unit.
Input Voltage	BA78M05	7.5	25	V
	BA78M06	8.5	21	
	BA78M07	9.5	22	
	BA78M08	10.5	23	
	BA78M09	11.5	26	
	BA78M10	12.5	25	
	BA78M12	14.5	27	
	BA78M15	17.5	30	
	BA78M18	21	33	
	BA78M20	23	33	
	BA78M24	27	33	
Output Current	Io	-	0.5	A

●Electrical Characteristics BA78M□□CP/FP

(Ta=25°C, Vin=10V(05), 11V(06), 13V(07), 14V(08), 15V(09), 16V(10), 19V(12), 23V(15), 27V(18), 29V(20), 33V(24), Io=350mA unless otherwise specified)

Parameter	Symbol	Type	Limit			Unit	Condition
			Min	Typ	Max		
Output Voltage 1	Vo1	05	4.8	5.0	5.2	V	Io=350mA
		06	5.75	6.0	6.25		
		07	6.7	7.0	7.3		
		08	7.7	8.0	8.3		
		09	8.6	9.0	9.4		
		10	9.6	10.0	10.4		
		12	11.5	12.0	12.5		
		15	14.4	15.0	15.6		
		18	17.3	18.0	18.7		
		20	19.2	20.0	20.8		
		24	23.0	24.0	25.0		
Output Voltage 2	Vo2	05	4.75	-	5.25	V	Vin=7.5~20V, Io=5mA~350mA
		06	5.7	-	6.3		Vin=8.5~21V, Io=5mA~350mA
		07	6.65	-	7.35		Vin=9.5~22V, Io=5mA~350mA
		08	7.6	-	8.4		Vin=10.5~23V, Io=5mA~350mA
		09	8.55	-	9.45		Vin=11.5~24V, Io=5mA~350mA
		10	9.5	-	10.5		Vin=12.5~25V, Io=5mA~350mA
		12	11.4	-	12.6		Vin=15~27V, Io=5mA~350mA
		15	14.25	-	15.75		Vin=17.5~30V, Io=5mA~350mA
		18	17.1	-	18.9		Vin=21~33V, Io=5mA~350mA
		20	19.0	-	21.0		Vin=23~33V, Io=5mA~350mA
		24	22.8	-	25.2		Vin=27~33V, Io=5mA~350mA
Line Regulation 1	Reg.I1	05	-	3	100	mV	Vin=7~25V, Io=200mA
		06	-	3	100		Vin=8~25V, Io=200mA
		07	-	4	100		Vin=9~25V, Io=200mA
		08	-	4	100		Vin=10.5~25V, Io=200mA
		09	-	4	100		Vin=11.5~26V, Io=200mA
		10	-	5	100		Vin=12.5~28V, Io=200mA
		12	-	5	100		Vin=14.5~30V, Io=200mA
		15	-	6	100		Vin=17.5~30V, Io=200mA
		18	-	7	100		Vin=21~33V, Io=200mA
		20	-	8	100		Vin=23~33V, Io=200mA
		24	-	10	100		Vin=27~33V, Io=200mA
Line Regulation 2	Reg.I2	05	-	1	50	mV	Vin=8~12V, Io=200mA
		06	-	1	50		Vin=9~25V, Io=200mA
		07	-	1	50		Vin=10~25V, Io=200mA
		08	-	1	50		Vin=11~25V, Io=200mA
		09	-	2	50		Vin=12~25V, Io=200mA
		10	-	2	50		Vin=14~26V, Io=200mA
		12	-	3	50		Vin=16~30V, Io=200mA
		15	-	3	50		Vin=20~30V, Io=200mA
		18	-	3	50		Vin=24~33V, Io=200mA
		20	-	4	50		Vin=24~33V, Io=200mA
		24	-	5	50		Vin=28~33V, Io=200mA
Ripple Rejection	R.R.	05	62	78	-	dB	ein=1Vrms, f=120Hz, Io=100mA
		06	60	74	-		
		07	57	71	-		
		08	56	69	-		
		09	56	67	-		
		10	56	66	-		
		12	55	63	-		
		15	54	60	-		
		18	53	58	-		
		20	53	58	-		
		24	50	55	-		
Temperature Coefficient of Output Voltage	Tcvo	05	-	-1.0	-	mV/°C	Io=5mA, Tj=0~125°C
		06/07/08/09/10/12	-	-0.5	-		
		15/18	-	-0.6	-		
		20/24	-	-0.7	-		
Peak Output Current	Io-p	common	-	875	-	mA	Tj=25°C
Dropout Voltage	Vd	common	-	2.0	-	V	Io=500mA

●Electrical Characteristics BA78M□□CP/FP

(Ta=25°C, Vin=10V(05), 11V(06), 13V(07), 14V(08), 15V(09), 16V(10), 19V(12), 23V(15), 27V(18), 29V(20), 33V(24), Io=350mA unless otherwise specified)

Parameter	Symbol	Type	Limit			Unit	Condition
			Min	Typ	Max		
Load Regulation 1	Reg.L1	05	-	20	100	mV	Io=5mA~500mA
		06	-	20	120		
		07	-	20	140		
		08	-	20	160		
		09	-	20	180		
		10	-	20	200		
		12	-	20	240		
		15	-	20	300		
		18	-	20	360		
		20	-	20	400		
		24	-	20	480		
Load Regulation 2	Reg.L2	05	-	10	50	mV	Io=5mA~200mA
		06	-	10	60		
		07	-	10	70		
		08	-	10	80		
		09	-	10	90		
		10	-	10	100		
		12	-	10	120		
		15	-	10	150		
		18	-	10	180		
		20	-	10	200		
		24	-	10	240		
Output Noise Voltage	Vn	05	-	40	-	μV	f=10Hz~100kHz
		06	-	60	-		
		07	-	70	-		
		08	-	80	-		
		09	-	90	-		
		10	-	100	-		
		12	-	110	-		
		15	-	130	-		
		18	-	140	-		
		20	-	150	-		
		24	-	170	-		
Bias Current	Ib	common	-	4.5	6.0	mA	Io=0mA
Bias Current Change1	Ib1	common	-	-	0.5	mA	Io=5mA~350mA
Bias Current Change 2	Ib2	05	-	-	0.8	mA	Vin:8~25V, Io=200mA
		06	-	-	0.8		Vin:9~25V, Io=200mA
		07	-	-	0.8		Vin:10~25V, Io=200mA
		08	-	-	0.8		Vin:10.5~25V, Io=200mA
		09	-	-	0.8		Vin:12~25V, Io=200mA
		10	-	-	0.8		Vin:13~25V, Io=200mA
		12	-	-	0.8		Vin:14.5~30V, Io=200mA
		15	-	-	0.8		Vin:17.5~30V, Io=200mA
		18	-	-	0.8		Vin:21~33V, Io=200mA
		20	-	-	0.8		Vin:23~33V, Io=200mA
		24	-	-	0.8		Vin:27~33V, Io=200mA
Short-Circuit Output Current	Ios	05/06/07/08	-	0.4	-	A	Vin=25V
		09/10/12/15/18/20/24	-	0.17	-		Vin=30V
Output Resistance	Ro	05	-	9	-	mΩ	f=1kHz
		06	-	10	-		
		07	-	11	-		
		08	-	12	-		
		09	-	13	-		
		10	-	14	-		
		12	-	16	-		
		15	-	19	-		
		18	-	22	-		
		20	-	25	-		
		24	-	37	-		

●Electrical Characteristics BA78□□CP/FP

(Ta=25°C, Vin=10V(05), 11V(06), 13V(07), 14V(08), 15V(09), 16V(10), 19V(12), 23V(15), 27V(18), 29V(20), 33V(24), Io=500mA unless otherwise specified)

Parameter	Symbol	Type	Limit			Unit	Condition
			Min	Typ	Max		
Output Voltage 1	Vo1	05	4.8	5.0	5.2	V	Io=500mA
		06	5.75	6.0	6.25		
		07	6.7	7.0	7.3		
		08	7.7	8.0	8.3		
		09	8.6	9.0	9.4		
		10	9.6	10.0	10.4		
		12	11.5	12.0	12.5		
		15	14.4	15.0	15.6		
		18	17.3	18.0	18.7		
		20	19.2	20.0	20.8		
		24	23.0	24.0	25.0		
Output Voltage 2	Vo2	05	4.75	-	5.25	V	Vin=7.5~20V, Io=5mA~1A
		06	5.7	-	6.3		Vin=8.5~21V, Io=5mA~1A
		07	6.65	-	7.35		Vin=9.5~22V, Io=5mA~1A
		08	7.6	-	8.4		Vin=10.5~23V, Io=5mA~1A
		09	8.55	-	9.45		Vin=11.5~26V, Io=5mA~1A
		10	9.5	-	10.5		Vin=12.5~25V, Io=5mA~1A
		12	11.4	-	12.6		Vin=15~27V, Io=5mA~1A
		15	14.25	-	15.75		Vin=17.5~30V, Io=5mA~1A
		18	17.1	-	18.9		Vin=21~33V, Io=5mA~1A
		20	19.0	-	21.0		Vin=23~33V, Io=5mA~1A
		24	22.8	-	25.2		Vin=27~33V, Io=5mA~1A
Line Regulation 1	Reg.I1	05	-	3	100	mV	Vin=7~25V, Io=500mA
		06	-	4	120		Vin=8~25V, Io=500mA
		07	-	5	140		Vin=9~25V, Io=500mA
		08	-	5	160		Vin=10.5~25V, Io=500mA
		09	-	6	180		Vin=11.5~26V, Io=500mA
		10	-	7	200		Vin=12.5~27V, Io=500mA
		12	-	8	240		Vin=14.5~30V, Io=500mA
		15	-	9	300		Vin=17.5~30V, Io=500mA
		18	-	10	360		Vin=21~33V, Io=500mA
		20	-	12	400		Vin=23~33V, Io=500mA
		24	-	15	480		Vin=27~33V, Io=500mA
Line Regulation 2	Reg.I2	05	-	1	50	mV	Vin=8~12V, Io=500mA
		06	-	2	60		Vin=9~13V, Io=500mA
		07	-	2	70		Vin=10~15V, Io=500mA
		08	-	3	80		Vin=11~17V, Io=500mA
		09	-	4	90		Vin=13~19V, Io=500mA
		10	-	4	100		Vin=14~20V, Io=500mA
		12	-	5	120		Vin=16~22V, Io=500mA
		15	-	5	150		Vin=20~26V, Io=500mA
		18	-	5	180		Vin=24~30V, Io=500mA
		20	-	7	200		Vin=26~32V, Io=500mA
		24	-	10	240		Vin=30~33V, Io=500mA
Ripple Rejection	R.R.	05	62	78	-	dB	ein=1Vrms, f=120Hz, Io=100mA
		06	59	73	-		
		07	57	69	-		
		08	56	65	-		
		09	56	64	-		
		10	55	64	-		
		12	55	63	-		
		15	54	62	-		
		18	53	61	-		
		20	53	60	-		
		24	50	58	-		
Temperature Coefficient of Output Voltage	Tcvo	05	-	-1.0	-	mV/°C	Io=5mA, Tj=0~125°C
		06/07/08/09/10/12	-	-0.5	-		
		15/18	-	-0.6	-		
		20/24	-	-0.7	-		
Peak Output Current	Io-p	common	-	1.7	-	A	Tj=25°C
Dropout Voltage	Vd	common	-	2.0	-	V	Io=1A

●Electrical Characteristics BA78□□CP/FP

(Ta=25°C,Vin=10V(05),11V(06),13V(07),14V(08),15V(09),16V(10),19V(12),23V(15),27V(18),29V(20),33V(24),Io=500mA unless otherwise specified)

Parameter	Symbol	Type	Limit			Unit	Condition
			Min	Typ	Max		
Load Regulation 1	Reg.L1	05	-	15	100	mV	Io=5mA~1A
		06	-	16	120		
		07	-	17	140		
		08	-	19	160		
		09	-	20	180		
		10	-	21	200		
		12	-	23	200		
		15	-	27	300		
		18	-	30	360		
		20	-	32	400		
Load Regulation 2	Reg.L2	24	-	37	480	mV	Io=250mA~750mA
		05	-	5	50		
		06	-	6	60		
		07	-	6	70		
		08	-	7	80		
		09	-	8	90		
		10	-	8	90		
		12	-	10	100		
		15	-	10	150		
		18	-	12	180		
Output Noise Voltage	Vn	20	-	14	200	μV	f=10Hz~100kHz
		24	-	15	240		
		05	-	40	-		
		06	-	60	-		
		07	-	70	-		
		08	-	80	-		
		09	-	90	-		
		10	-	100	-		
		12	-	110	-		
		15	-	125	-		
Bias Current	Ib	common	-	4.5	8.0	mA	Io=0mA
Bias Current Change 1	Ib1	common	-	-	0.5	mA	Io=5mA~1A
Bias Current Change 2	Ib2	05	-	-	0.8	mA	Vin:8~25V, Io=500mA
		06	-	-	0.8		Vin:8.5~25V, Io=500mA
		07	-	-	0.8		Vin:9.5~25V, Io=500mA
		08	-	-	0.8		Vin:10.5~25V, Io=500mA
		09	-	-	0.8		Vin:11.5~26V, Io=500mA
		10	-	-	0.8		Vin:12.5~27V, Io=500mA
		12	-	-	0.8		Vin:14.5~30V, Io=500mA
		15	-	-	0.8		Vin:17.5~30V, Io=500mA
		18	-	-	0.8		Vin:21~33V, Io=500mA
		20	-	-	0.8		Vin:23~33V, Io=500mA
Short-Circuit Output Current	Ios	05/06/07/08	-	0.6	-	A	Vin=25V
		09/10/12/15/18/20/24	-	0.3	-		Vin=30V
Output Resistance	Ro	05	-	9	-	mΩ	f=1kHz
		06	-	10	-		
		07	-	10	-		
		08	-	10	-		
		09	-	10	-		
		10	-	11	-		
		12	-	12	-		
		15	-	14	-		
		18	-	17	-		
		20	-	19	-		
		24	-	27	-		

●BA78M□□ Characteristics data ($T_a=25^\circ\text{C}$, $V_{in}=10\text{V}(05)$, $14\text{V}(08)$, $23\text{V}(15)$ unless otherwise specified)

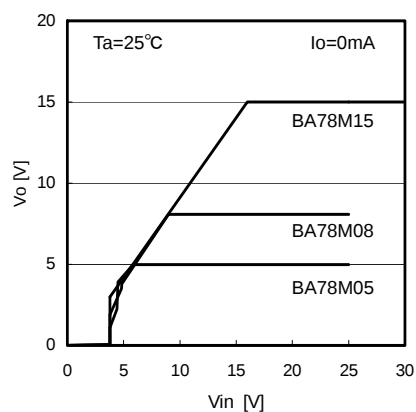
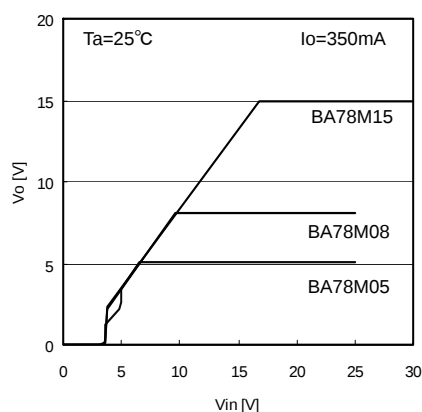
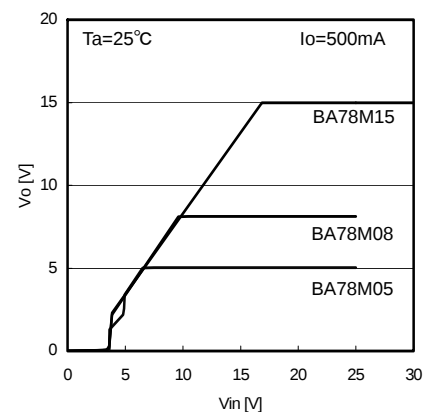
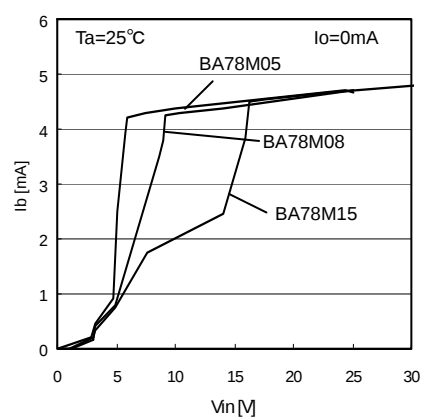
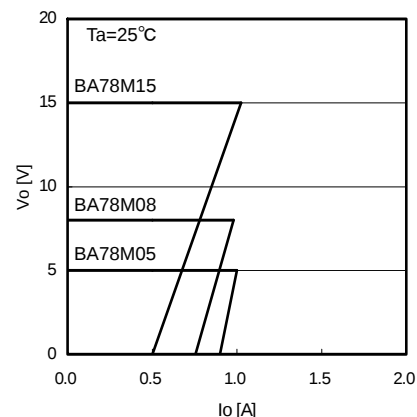
Fig.1 Line Regulation ($I_o=0\text{mA}$)Fig.2 Line Regulation ($I_o=350\text{mA}$)Fig.3 Line Regulation ($I_o=500\text{mA}$)Fig.4 $V_{in} - I_b$ 

Fig.5 Load Regulation

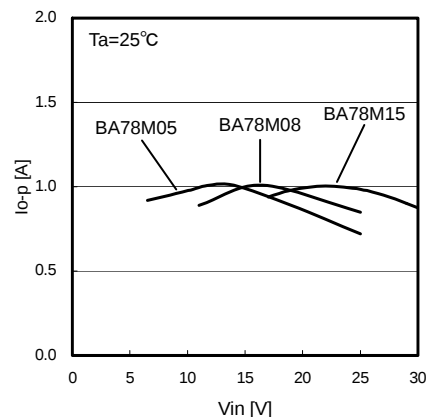


Fig.6 Peak Output Current

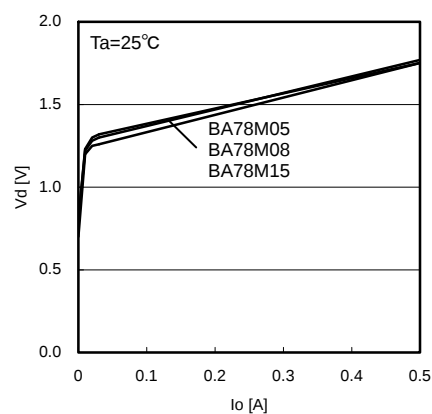


Fig.7 Dropout Voltage

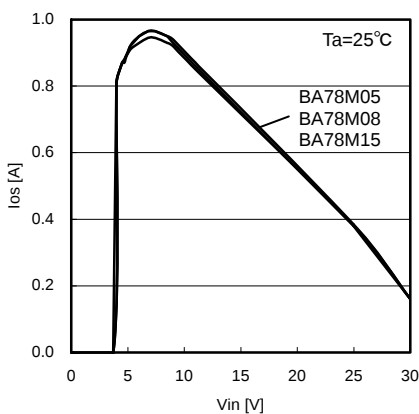


Fig.8 Short - Circuit Output Current

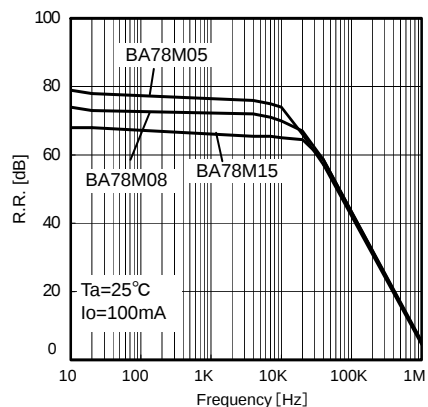
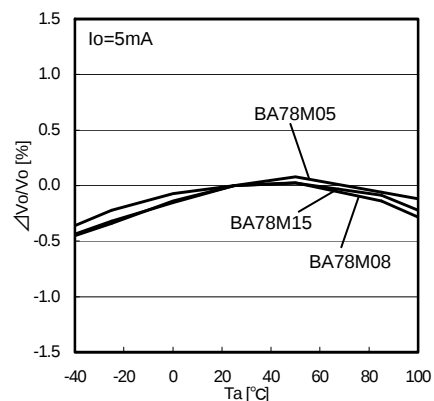
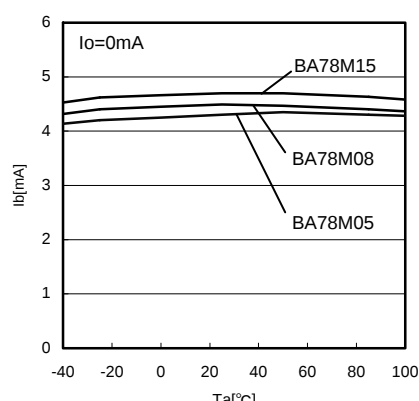
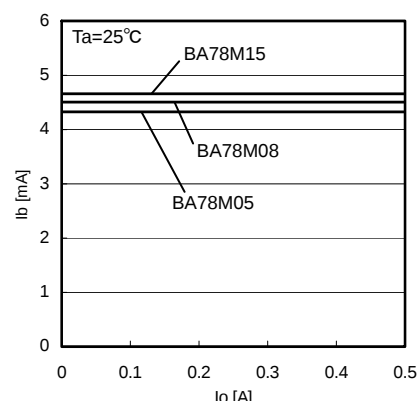


Fig.9 Ripple Rejection Ratio

Fig.10 $T_a - V_o$ Fig.11 $T_a - I_b$ Fig.12 $I_o - I_b$

●BA78□□ Characteristics data ($T_a=25^\circ\text{C}$, $V_{in}=10\text{V}(05)$, $14\text{V}(08)$, $23\text{V}(15)$ unless otherwise specified)

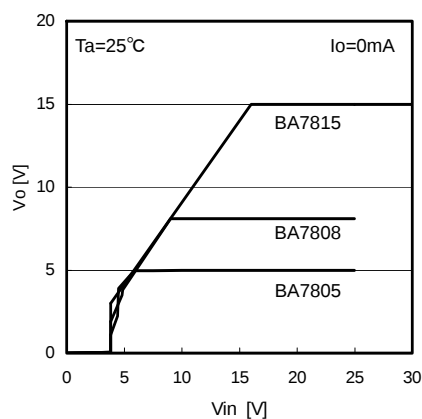
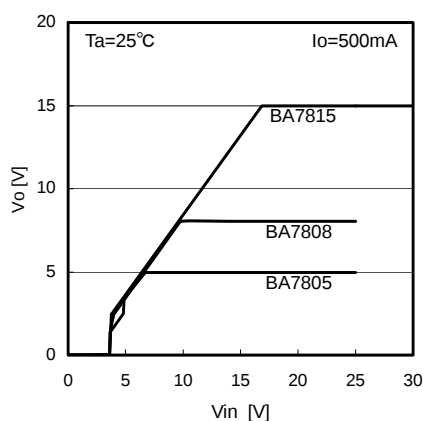
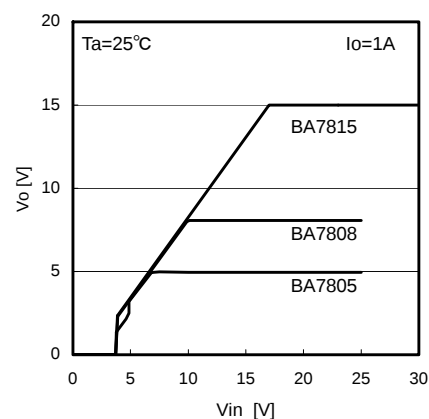
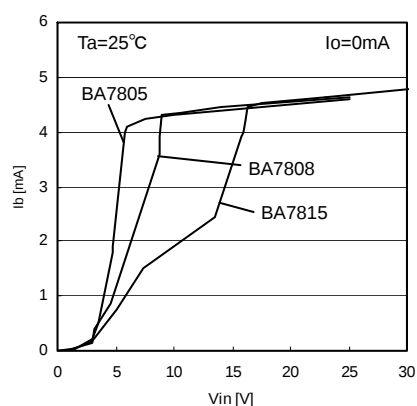
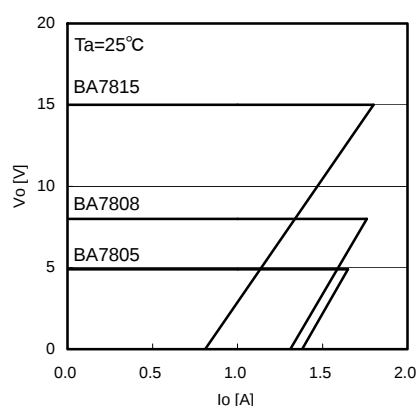
Fig.13 Line Regulation ($I_o=0\text{mA}$)Fig.14 Line Regulation ($I_o=500\text{mA}$)Fig.15 Line Regulation ($I_o=1\text{A}$)Fig.16 $V_{in} - I_b$ 

Fig.17 Load Regulation

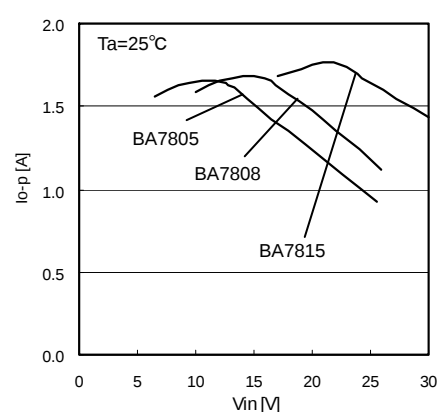


Fig.18 Peak Output Current

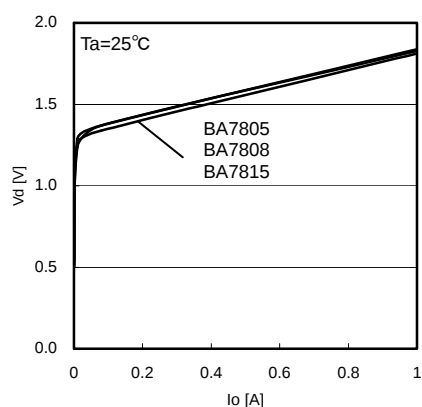


Fig.19 Dropout Voltage

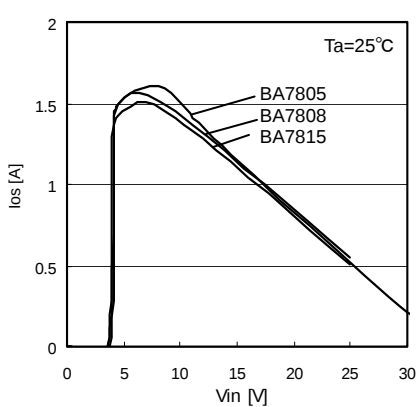


Fig.20 Short - Circuit Output Current

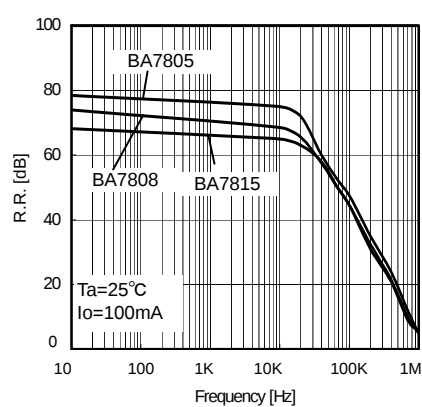
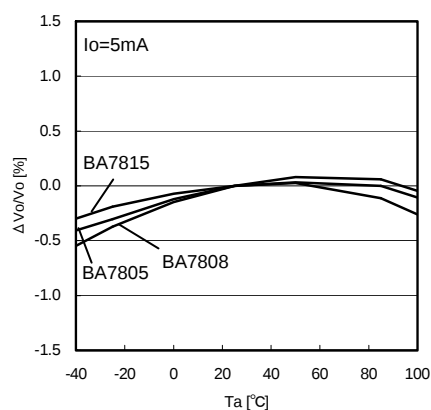
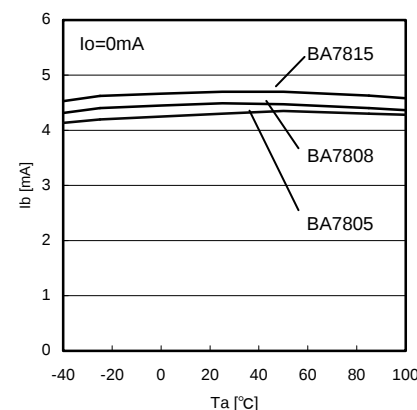
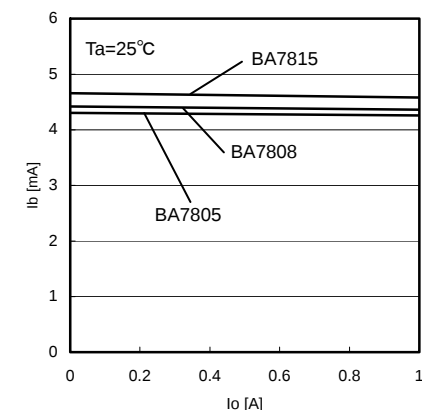
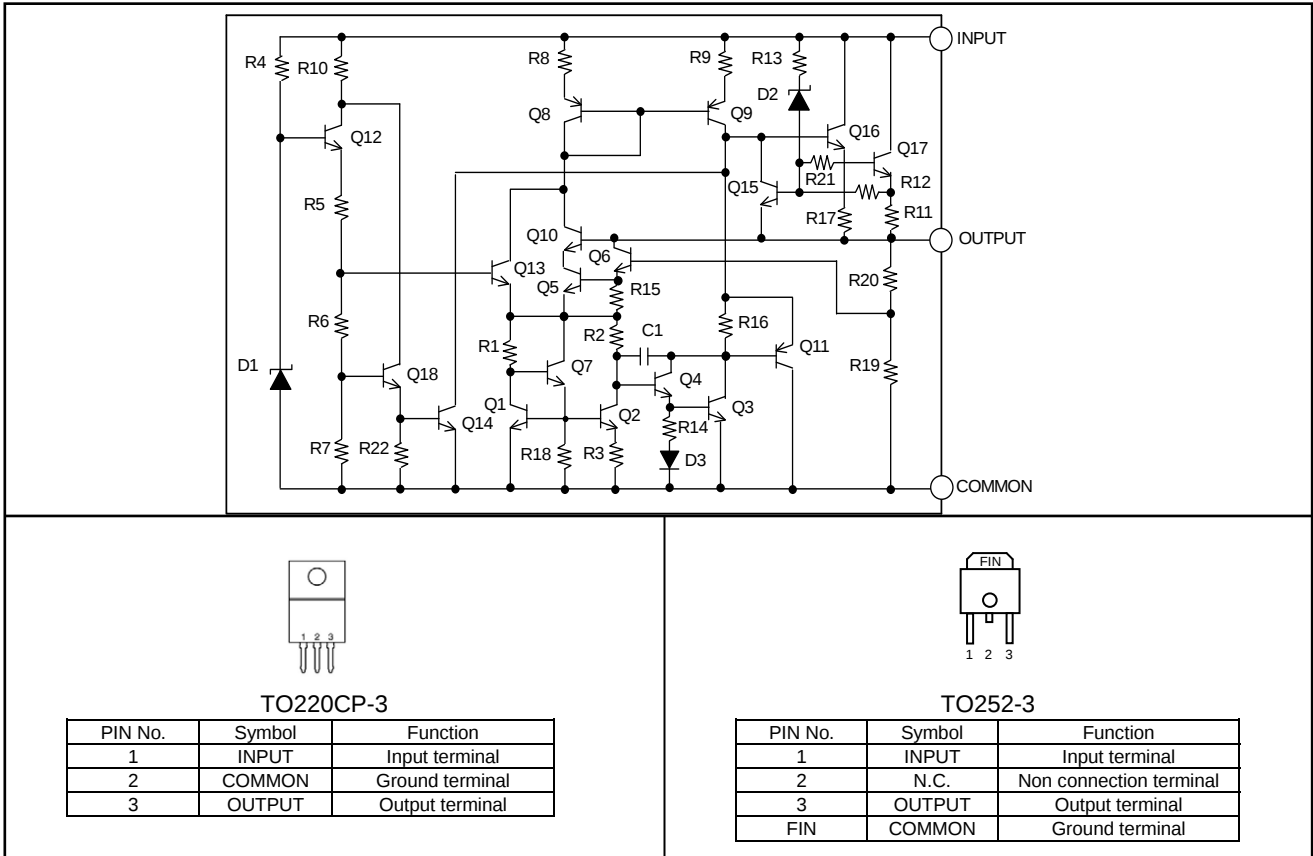


Fig.21 Ripple Rejection Ratio

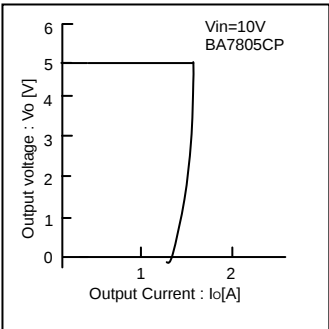
Fig.22 $T_a - V_o$ Fig.23 $T_a - I_b$ Fig.24 $I_o - I_b$

●Internal Circuit Structural Diagram

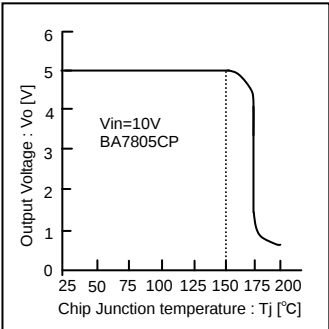


●Protection Circuit

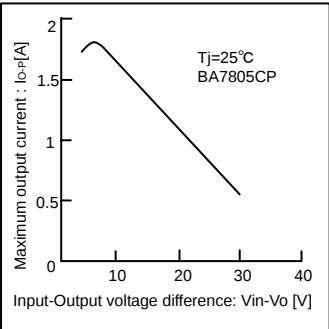
(1)Over-current protection circuit
When the maximum rating current or more is rushed, it controls the current ability and protects the IC from destruction.



(2) Thermal shutdown circuit
When the chip temperature of IC exceeds the setting temperature, the IC goes OFF, and it controls the IC not to be destroyed by the heat generation. It can be restored by being lowered the chip temperature of IC below the setting temperature.



(3) Safety operation area control circuit
It controls the output current in inverse proportion ratio to voltage difference (input-output).
When voltage difference becomes bigger, the IC will be destroyed in rush current. It protects the IC by controlling the current ability according to the voltage level.



●Thermal design

Refer to the following thermal derating curves (Fig. 25, 26), when using in the status of $T_a=25^\circ\text{C}$ or more.

The characteristic of IC is greatly related to the operating temperature.

When it is used in over maximum junction temperature, the elements inside IC might become weaker and be destroyed. It is recommended to take into consideration thermal of IC.

Note that the temperatures are in the allowed temperature limits and operated within P_d .

It is necessary to operate it at junction temperature $T_{j\text{max}}$ or less to prevent IC from the thermal destruction.

Please operate IC within permissible loss P_d because the junction temperature T_j might become considerably a high temperature even if ambient temperature T_a is normal temperature (25°C).

Power consumption $P_c(\text{W})$ may be expressed by the equation shown below:

$$P_c = (V_{in} - V_o) \times I_o + V_{in} \times I_b$$

$$\text{permissible loss } P_d \geq P_c$$

$$I_o \leq \frac{P_d - V_{in} \times I_b}{V_{in} - V_o}$$

V_{in} : Input Voltage
 V_o : Output Voltage
 I_o : Output Current
 I_b : Bias current

Maximum Output current $I_{o\text{MAX}}$ can be calculated in thermal design.

• Calculation example

Ex.1) $T_a=85^\circ\text{C}$, $V_{in}=7.5\text{V}$, $V_o=5.0\text{V}$

$$I_o \leq \frac{1.04 - 7.5 \times 4.5\text{mA}}{7.5 - 5.0}$$

$$I_o \leq 400\text{mA}$$

Using TO220CP-3 alone
 $\theta_{ja}=62.5^\circ\text{C/W} \rightarrow 16\text{mW}/^\circ\text{C}$
 $P_d=1.04\text{W}$ at 85°C

Be sure to use this IC within a power dissipation at the range of operating temperature.

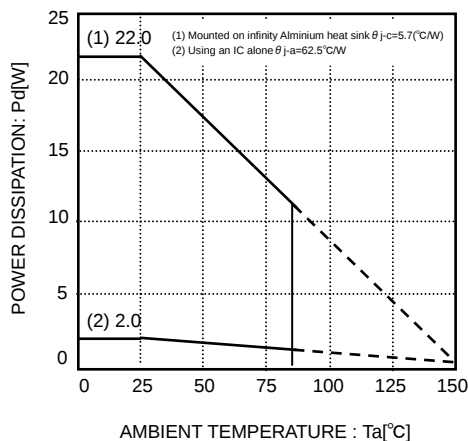


Fig.25 Thermal derating curve (TO220CP-3)

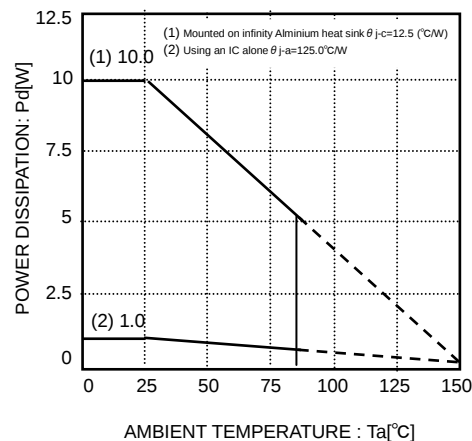


Fig.26 Thermal derating curve (TO252-3)

●Terminal Setting and Cautions

• INPUT

It is recommended that a capacitor (about $0.33\mu\text{F}$) be inserted between INPUT and COMMON. The value of capacitor is designed suitable for the actual application.

• OUTPUT

It is recommended that a capacitor (about $0.1\mu\text{F}$) be inserted between OUTPUT and COMMON. A tantalum capacitor can also be used for this pin because insufficient capacitors may cause oscillation by a temperature change.

• COMMON

Keep the no voltage drop between Ground level of set board and IC.

When there is the voltage difference, setting voltage becomes inaccuracy and unstable.

It is recommended to connect by wide, short pattern, and lower the impedance.

Notes for use

(1) Absolute Maximum Ratings

While utmost care is taken to quality control of this product, any application that may exceed some of the absolute maximum ratings including the voltage applied and the operating temperature range may result in breakage. If broken, short-mode or open-mode may not be identified. So if it is expected to encounter with special mode that may exceed the absolute maximum ratings, it is requested to take necessary safety measures physically including insertion of fuses.

(2) Ground voltage

Make setting of the potential of the GND terminal so that it will be maintained at the minimum in any operating state. Furthermore, check to be sure no terminals are at a potential lower than the GND voltage including an actual electric transient.

(3) Thermal design

When you do the kind of use which exceeds P_d , It may be happened to deteriorating IC original quality such as decrease of electric current ability with chip temperature rise. Do not exceed the power dissipation (P_d) of the package specification rating under actual operation, and please design enough temperature margins.

(4) Short-circuiting between terminals, and mismounting

When mounting to pc board, care must be taken to avoid mistake in its orientation and alignment. Failure to do so may result in IC breakdown. Short-circuiting due to foreign matters entered between output terminals, or between output and power supply or GND may also cause breakdown.

(5) Operation in Strong electromagnetic field

Be noted that using the IC in the strong electromagnetic radiation can cause operation failures.

(6) Inspection with the IC set to a pc board

If a capacitor must be connected to the pin of lower impedance during inspection with the IC set to a pc board, the capacitor must be discharged after each process to avoid stress to the IC. For electrostatic protection, provide proper grounding to assembling processes with special care taken in handling and storage. When connecting to jigs in the inspection process, be sure to turn OFF the power supply before it is connected and removed.

(7) Input to IC terminals

This is a monolithic IC with P^+ isolation between P-substrate and each element as illustrated below. This P-layer and the N-layer of each element form a P-N junction, and various parasitic element are formed.

If a resistor is joined to a transistor terminal as shown in Fig 28.

OP-N junction works as a parasitic diode if the following relationship is satisfied;

GND > Terminal A (at resistor side), or GND > Terminal B (at transistor side); and

Or if GND > Terminal B (at NPN transistor side),

a parasitic NPN transistor is activated by N-layer of other element adjacent to the above-mentioned parasitic diode.

The structure of the IC inevitably forms parasitic elements, the activation of which may cause interference among circuits, and/or malfunctions contributing to breakdown. It is therefore requested to take care not to use the device in such manner that the voltage lower than GND (at P-substrate) may be applied to the input terminal, which may result in activation of parasitic elements.

(8) Ground wiring pattern

If small-signal GND and large-current GND are provided, It will be recommended to separate the large-current GND pattern from the small-signal GND pattern and establish a single ground at the reference point of the set PCB so that resistance to the wiring pattern and voltage fluctuations due to a large current will cause no fluctuations in voltages of the small-signal GND. Pay attention not to cause fluctuations in the GND wiring pattern of external parts as well.

(9) Thermal shutdown circuit

A temperature control circuit is built in the IC to prevent the damage due to overheat. Therefore, the output is turned off when the thermal circuit works and is turned on when the temperature goes down to the specified level.

But, built-in the IC a temperature control circuit to protect itself, and avoid the design used the thermal protection.

(10) Over current protection circuit

The over-current protection circuits are built in at output, according to their respective current outputs and prevent the IC from being damaged when the load is short-circuited or over-current. But, these protection circuits are effective for preventing destruction by unexpected accident. When it's in continuous protection circuit moving period don't use please. And for ability, because this chip has minus characteristic, be careful for heat plan.

(11) There is a possibility to damage an internal circuit or the element when V_{in} and the voltage of each terminal reverse in the application. For instance, V_{in} is short-circuited to GND etc. with the charge charged to an external capacitor. Please use the capacitor of the output terminal with 1000 μ F or less. Moreover, the V_{in} series is recommended to insert the diode of the by-pass the diode of the backflow prevention or between each terminal and V_{in} .

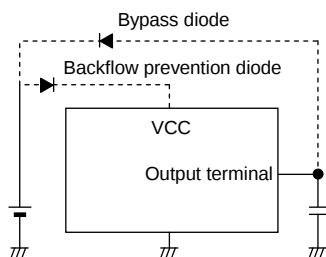


Fig.27 Bypass Diode

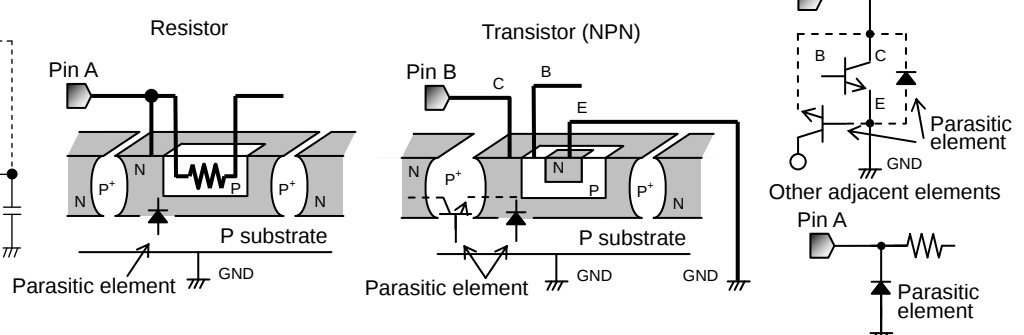
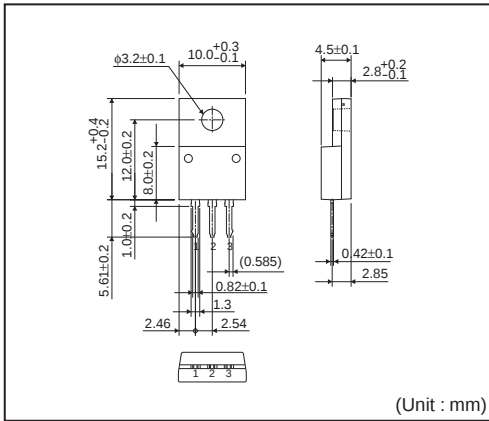


Fig.28 Simplified structure of monoristic IC

●Ordering part number

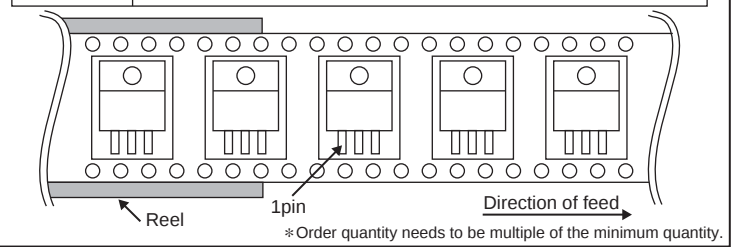
B A	7 8	M	0 5	F P	- E 2
Part No	Part No				
		Output Current None : 1A M : 0.5A	Output Voltage 05 : 5V : } 24 : 24V	Package CP : TO220CP-3 FP : TO252-3	Packaging and forming specification E2: Embossed tape and reel (TO220CP-3, TO252-3)

TO220CP-3

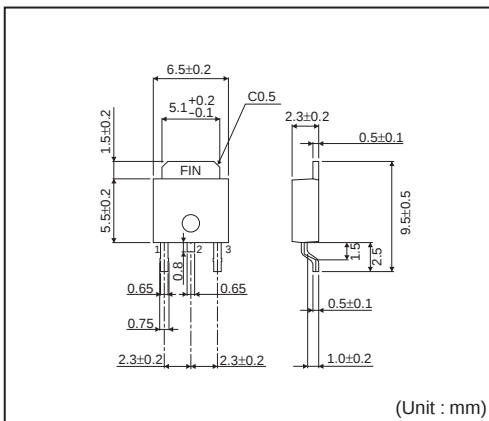


<Tape and Reel information>

Tape	Embossed carrier tape
Quantity	500pcs
Direction of feed	E2 (The direction is the 1pin of product is at the lower left when you hold reel on the left hand and you pull out the tape on the right hand)

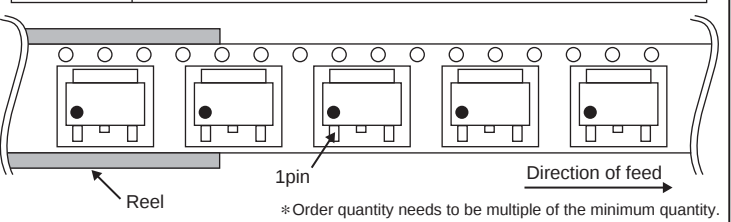


TO252-3



<Tape and Reel information>

Tape	Embossed carrier tape
Quantity	2000pcs
Direction of feed	E2 (The direction is the 1pin of product is at the lower left when you hold reel on the left hand and you pull out the tape on the right hand)



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JAPAN	USA	EU	CHINA
CLASS III	CLASS III	CLASS II b	CLASS III
CLASS IV		CLASS III	

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 - Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - Sealing or coating our Products with resin or other coating materials
 - Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - Use of the Products in places subject to dew condensation
- The Products are not subject to radiation-proof design.
- Please verify and confirm characteristics of the final or mounted products in using the Products.
- In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- In principle, the reflow soldering method must be used; if flow soldering method is preferred, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of ionizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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